

30A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER

Features

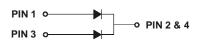
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- Surge Overload Rating to 250A Peak
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish/RoHS Compliant Version (Note 1)

Mechanical Data

- Case: TO-263
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Tin. Solderable per MIL-STD-202, Method 208 63
- Polarity: See Diagram
- Weight: 1.7 grams (approximate)



Top View



Polarity

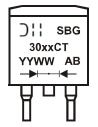
Ordering Information (Note 2)

| Part Number | Case | Packaging |
|---------------|--------|--------------------------|
| SBG3030CT-T-F | TO-263 | 800/Tape & Reel, 13-inch |
| SBG3040CT-T-F | TO-263 | 800/Tape & Reel, 13-inch |
| SBG3045CT-T-F | TO-263 | 800/Tape & Reel, 13-inch |

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes
- 2. For packaging details, go to our website at http://www.diodes.com.

Marking Information



SBG30xxCT = Product Type Marking Code Where xx = 30, 40, or 45 Depending on Device Type 3!! = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 2 for 2002) WW = Week Code (01 - 53)



Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

| Characteristic | | Symbol | SBG 3030CT | SBG 3040CT | SBG 3045CT | Unit |
|---|--------------------------|-----------------------------|---------------|---------------|---------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 3) | | $V_{RRM} \ V_{RWM} \ V_{R}$ | 30 | 40 | 45 | > |
| RMS Reverse Voltage | | V _{R(RMS)} | 21 | 28 | 32 | V |
| Average Rectified Output Current | @ T _C = 100°C | lo | | 30 | | Α |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load | | I _{FSM} | | 250 | | А |

Thermal Characteristics

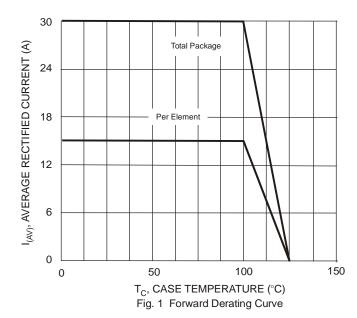
| Characteristic | Symbol | Value | Unit |
|--|------------------|-------------|------|
| Typical Thermal Resistance Junction to Case (Note 4) | $R_{	heta JC}$ | 1.5 | °C/W |
| Operating Temperature Range | TJ | -55 to +125 | °C |
| Storage Temperature Range | T _{STG} | -55 to +150 | °C |

Electrical Characteristics @T_A = 25°C unless otherwise specified

| Characteristic | | Symbol | Value | Unit |
|---------------------------------------|----------------------------------|----------------|-------|------|
| Forward Voltage, per Element | $@ I_F = 15A, T_C = 25^{\circ}C$ | V_{FM} | 0.55 | V |
| Peak Reverse Current | @ T _J = 25°C | I | 1.0 | mA |
| at Rated DC Blocking Voltage (Note 3) | @ T _J = 100°C | IRM | 75 | IIIA |
| Typical Total Capacitance (Note 5) | | C _T | 420 | pF |

Notes:

- 3. Short duration pulse test used to minimize self-heating effect.
- 4. Thermal resistance junction to case mounted on heatsink.
- 5. Measured at 1.0 MHz and applied reverse voltage of 4.0V DC and per element.



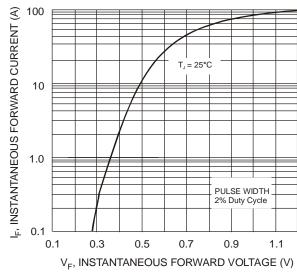
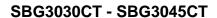
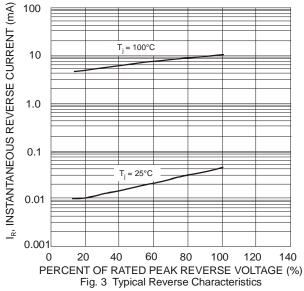


Fig. 2 Typical Forward Characteristics, Per Element







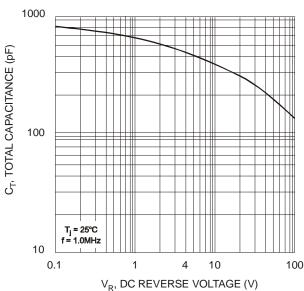
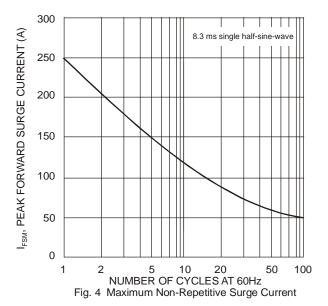
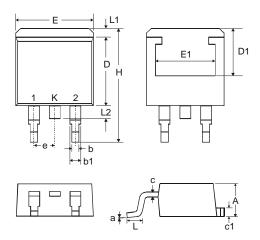


Fig. 5 Typical Total Capacitance, Per Element



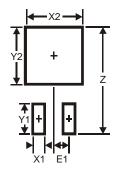


Package Outline Dimensions



| TO263 | | | |
|----------------------|----------|-------|--|
| Dim | Min | Max | |
| Α | 4.07 | 4.82 | |
| b | 0.51 | 0.99 | |
| b1 | 1.15 | 1.77 | |
| С | 0.356 | 0.58 | |
| c1 | 1.143 | 1.65 | |
| D | 8.39 | 9.65 | |
| D1 | 6.55 | _ | |
| E | 9.66 | 10.66 | |
| E1 | 6.23 | _ | |
| е | 2.54 Typ | | |
| Н | 14.61 | 15.87 | |
| L | 1.78 | 2.79 | |
| L1 | _ | 1.67 | |
| L2 | _ | 1.77 | |
| а | 0° | 8° | |
| All Dimensions in mm | | | |

Suggested Pad Layout



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 16.9 |
| X1 | 1.1 |
| X2 | 10.8 |
| Y1 | 3.5 |
| Y2 | 7.01 |
| E1 | 2.5 |



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